

Parameter	Rating	Units
AC Operating Voltage	260	V <sub>rms</sub>
Load Current	1	A <sub>rms</sub>
On State Voltage Drop	1.6	$V_{rms}$ (at $I_L = 1A_{rms}$ )

#### **Features**

- Load Current up to 1A<sub>rms</sub>
- 600V<sub>P</sub> Blocking Voltage
- 5mA Sensitivity
- · Zero-Crossing Detection
- DC Control, AC Output
- · Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- · Machine Insertable, Wave Solderable
- Flammability Classification Rating of V-0

### **Applications**

- Programmable Control
- Process Control
- · Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

## **Description**

The CPC1965Y is an AC Solid State Relay (SSR) using patented waveguide coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The switches are robust enough to provide a blocking voltage of up to  $600V_p$ . In addition, tightly controlled zero-cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide  $3750V_{rms}$  of isolation and noise immunity between control and load circuits. As a result, the CPC1965Y is well suited for industrial environments where electromagnetic interference could disrupt the operation of electromechanical relays.

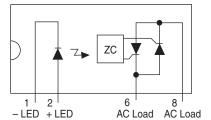
### **Approvals**

- UL Recognized Component: File E69938
- CSA Certified Component: File 043639

# **Ordering Information**

Part #	Description
CPC1965Y	4-Pin (8-Pin Body) SIP (25/Tube)

## **Pin Configuration**











# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units	
Blocking Voltage	600	$V_{P}$	
Reverse Input Voltage	5	V	
Input Control Current	100	mA	
Peak (10ms)	1	Α	
Input Power Dissipation <sup>1</sup>	150	mW	
PD, Total Package Dissipation <sup>2</sup>	1600	mW	
Isolation Voltage, Input to Output	3750	$V_{rms}$	
Operational Temperature	-40 to +85	°C	
Storage Temperature	-40 to +125	°C	

excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Absolute Maximum Ratings are stress ratings. Stresses in

## Electrical Characteristics @ 25°C

V <sub>L</sub>				,	
•					
-	-	20	-	260	V <sub>rms</sub>
$V_1 = 120 - 260 V_{rms}$	I <sub>I</sub>	0.005	-	1.0	A <sub>rms</sub>
-	I <sub>TSM</sub>	-	-	10	A
V <sub>I</sub> =600V <sub>P</sub>	1	-	-	1	mA
I <sub>L</sub> =1A <sub>rms</sub>	-	-	-	1.6	V <sub>rms</sub>
-	dV/dt	1000	-	-	V/µs
I E mA	t <sub>on</sub>	-	-	0.5	avalaa
I <sub>F</sub> =5 MA		-	-	0.5	cycles
1st half-cycle	-	-	2	10	V
Subsequent half-cycle	-	-	1	-	V
-	-	20	-	400	Hz
-	PF	0.25	-	-	-
-	I <sub>F</sub>	-	0.8	5	mA
I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
-	-	0.8	-	-	V
V <sub>R</sub> =5V	I <sub>B</sub>	-	-	10	μΑ
-	C <sub>I/O</sub>	-	3	-	pF
	I <sub>E</sub> =1A <sub>rms</sub> - I <sub>F</sub> =5 mA - 1st half-cycle Subsequent half-cycle I <sub>F</sub> =5mA - V <sub>R</sub> =5V	- I <sub>TSM</sub> V <sub>L</sub> =600V <sub>P</sub> I <sub>LEAK</sub> I <sub>L</sub> =1A <sub>rms</sub> - dV/dt  I <sub>F</sub> =5 mA t <sub>on</sub> 1st half-cycle - Subsequent half-cycle PF  - PF  - I <sub>F</sub> =5mA V <sub>F</sub> - V <sub>R</sub> =5V I <sub>R</sub>	- I <sub>TSM</sub> - I <sub>LEAK</sub>	- I <sub>TSM</sub>	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

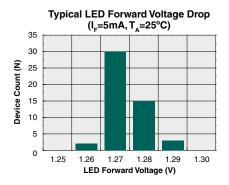
<sup>&</sup>lt;sup>1</sup> Derate linearly 1.33 mW / °C <sup>2</sup> Derate linearly 16.6 mW / °C

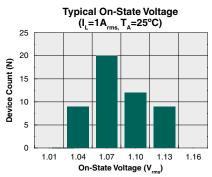
Zero Cross 1st half-cycle @ <100Hz</li>
 Snubber circuits may be required at low power factors.
 Tested in accordance with EIA/NARM standard RS-443.

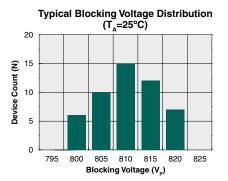
 $<sup>^{4}</sup>$  For high noise environments, use  $\rm I_{F}\!\!=\!\!10mA.$ 

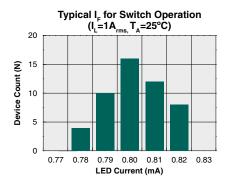


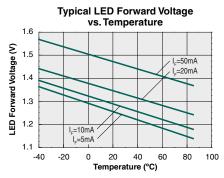
#### **PERFORMANCE DATA\***

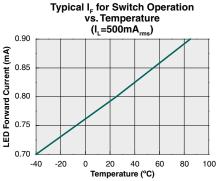


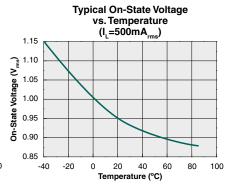








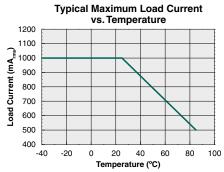


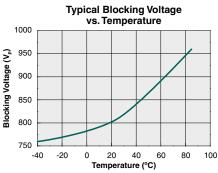


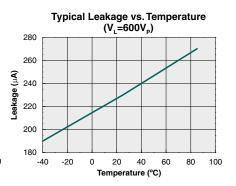
<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

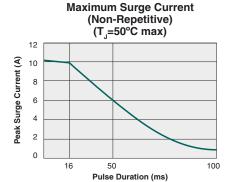


## **PERFORMANCE DATA\***









<sup>\*</sup>The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



## **Manufacturing Information**

## **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1965Y	MSL 1

## **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

#### **Reflow Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1965Y	245°C for 30 seconds

#### **Board Wash**

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



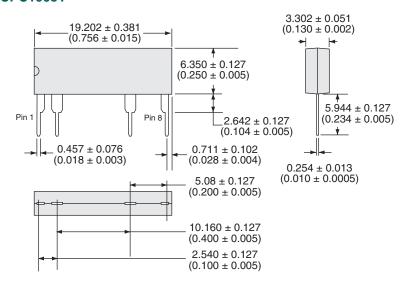




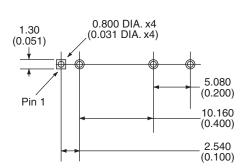


#### **MECHANICAL DIMENSIONS**

#### **CPC1965Y**



#### **PCB Hole Pattern**



Dimensions mm (inches)

## For additional information please visit our website at: www.ixysic.com

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